

EXAMINER SEARCH (TEXT)

| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|--|---|------------------|
| - | 1 | ((flexible adj interconnect) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 18:06 |
| - | 5 | ((flexible adj interconnect) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 17:50 |
| - | 72 | ((flexible near3 board) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 18:07 |
| - | 32 | ((flexible near3 board) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 17:51 |
| - | 8 | ((flexible near3 board) with (heat adj sink or heat adj spreader) with (hole\$1 or opening\$1 or via\$1)).ab,clm. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 17:52 |
| - | 24 | ((flexible near3 board) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.) not (((flexible near3 board) with (heat adj sink or heat adj spreader) with (hole\$1 or opening\$1 or via\$1)).ab,clm.) or (((flexible adj interconnect) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) or (((flexible adj interconnect) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 17:55 |
| - | 40 | ((flexible near3 board) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) not (((flexible near3 board) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.) or (((flexible near3 board) with (heat adj sink or heat adj spreader) with (hole\$1 or opening\$1 or via\$1)).ab,clm.) or (((flexible adj interconnect) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) or (((flexible adj interconnect) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 17:58 |
| - | 33 | ((flexible near3 film) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 17:58 |

| | | | | |
|---|--------|---|---|------------------|
| - | 29 | ((flexible near3 film) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) not (((flexible near3 board) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible near3 board) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.) or (((flexible near3 board) with (heat adj sink or heat adj spreader) with (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible adj interconnect) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible adj interconnect) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 18:07 |
| - | 1 | ((flexible adj interconnect) with (heat adj sink or heat adj spreader) with (hole\$1 or opening\$1 or via\$1)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 18:06 |
| - | 3 | ((flexible adj interconnect) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 18:06 |
| - | 540 | ((flexible near3 board) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 18:07 |
| - | 467 | ((flexible near3 board) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)) not (((flexible near3 film) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible near3 board) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible near3 board) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible near3 board) with (heat adj sink or heat adj spreader) with (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible adj interconnect) and (heat adj sink or heat adj spreader) and (hole\$1 or opening\$1 or via\$1)).ab,clm.) or ((flexible adj interconnect) same (heat adj sink or heat adj spreader) same (hole\$1 or opening\$1 or via\$1)).ab,clm.)) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2004/06/18 18:29 |
| - | 685940 | substrate or board or interconnect adj structure or circuit adj structure | USPAT | 2004/06/19 16:41 |
| - | 120137 | (substrate or board or interconnect adj structure or circuit adj structure) and flexible | USPAT | 2004/06/19 16:38 |
| - | 16256 | (substrate or board or interconnect adj structure or circuit adj structure) and (heat adj sink or heat adj spreader) | USPAT | 2004/06/19 16:38 |
| - | 4319 | ((substrate or board or interconnect adj structure or circuit adj structure) and flexible) and ((substrate or board or interconnect adj structure or circuit adj structure) and (heat adj sink or heat adj spreader)) | USPAT | 2004/06/19 16:39 |

| | | | | |
|---|------|--|-------|------------------|
| - | 2171 | ((substrate or board or interconnect adj structure or circuit adj structure) and flexible) and ((substrate or board or interconnect adj structure or circuit adj structure) and (heat adj sink or heat adj spreader))) and (LED or light emitting adj diode) | USPAT | 2004/06/19 16:40 |
| - | 1483 | ((substrate or board or interconnect adj structure or circuit adj structure) and flexible) and ((substrate or board or interconnect adj structure or circuit adj structure) and (heat adj sink or heat adj spreader))) and (LED or light emitting adj diode)) and (hole41 or opening\$1 or recess\$2) | USPAT | 2004/06/19 16:41 |
| - | 72 | ((substrate or board or interconnect adj structure or circuit adj structure) and flexible) and ((substrate or board or interconnect adj structure or circuit adj structure) and (heat adj sink or heat adj spreader))) and (LED or light emitting adj diode)) and (hole41 or opening\$1 or recess\$2)) and ((362/800).CCLS.) or ((361/760) or (361/688) or (361/697) or (361/709) or (361/713)).CCLS.) or ((174/262) or (174/261) or (174/263) or (174/264)).CCLS.) or ((174/15.2) or (174/254)).CCLS.) or ((174/260).CCLS.) or ((174/252).CCLS.)) | USPAT | 2004/06/19 16:44 |
| - | 5388 | flexible adj circuit\$1 or flexible adj circuit adj board or flexible adj wiring adj board | USPAT | 2004/06/25 09:42 |
| - | 320 | (flexible adj circuit\$1 or flexible adj circuit adj board or flexible adj wiring adj board) and 174/\$.ccls. and 361/\$.ccls. | USPAT | 2004/06/25 09:43 |
| - | 50 | ((flexible adj circuit\$1 or flexible adj circuit adj board or flexible adj wiring adj board) and 174/\$.ccls. and 361/\$.ccls.) and heat adj sink | USPAT | 2004/06/25 11:16 |